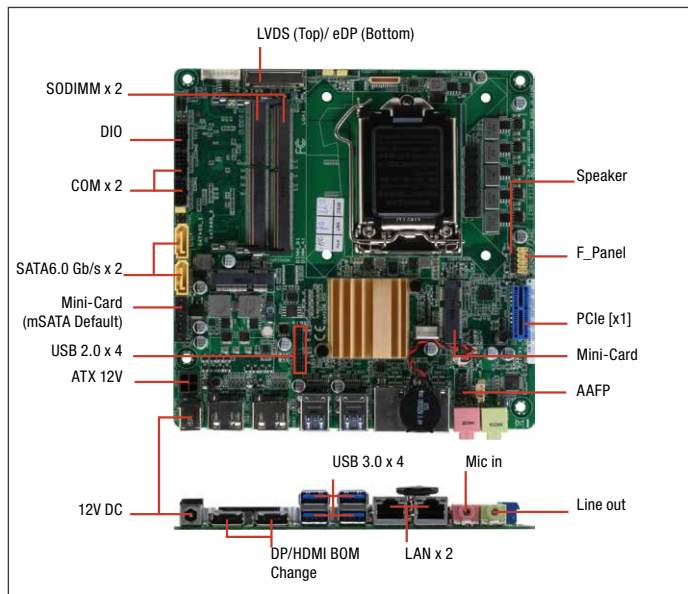


Intel® 6th Generation Core™ i Series, LGA1151 Socket Processor, Max. 65W TDPs, SATA 6.0 Gb/s x 2, USB x 8



Specifications

System	
Processor	Intel® 6th Generation Core™ i7/i5/i3, LGA1151 Socket Processor, Max. 65W TDPs
Chipset	Intel® H110
Memory	DDR4 2133/1867 MHz SODIMM x 2, Up to 32GB, Non-ECC, Un-buffered Memory, Dual channel memory architecture
Graphics	Intel® HD Graphics
I/O Chipset	NCT6791D
Ethernet	Realtek PCIe Gb LAN 8111G x 2
Audio	Realtek® ALC887
TPM	Infineon SLB96XX TT 1.2/2.0 (default: No)
Expansion Slots	PCIe [x1] x 1, Full-size Mini-Card (mSATA default) (PCIe+USB optional) x 1, Half-size Mini-Card (PCIe+USB) x 1
BIOS	64 M bit Flash ROM, AMI BIOS
H/W Monitor	Temperature Monitor on CPU/Chassis, Voltage Monitor on Vcore/5V/12V, Fan Monitor on CPU/Chassis
WatchDog Timer	1~255 step by software program
Smart Fan Control	CPU Fan/ Chassis Fan
Wake On LAN/ PXE	Yes (WOL/PXE)
Power State	S3, S4, S5
Graphics	
Graphics Chipset	—
Graphics Multi Display	HDMI1+HDMI2, HDMI1+DP2, DP1+HDMI2, HDMI1+LVDS, HDMI2+LVDS, HDMI1+eDP, HDMI2+eDP, DP1+DP2, DP1+LVDS, DP2+LVDS, DP1+eDP, DP2+eDP
VGA	—
DVI	—
HDMI	Up to 4096 x 2160 @24 Hz / 2560 x 1600 @60 Hz, with Digital Audio (HDMI/ DP Combo)
Display Port	Up to 4096 x 2160 @24 Hz / 3840 x 2160 @60 Hz, with Digital Audio (HDMI/ DP Combo)
LVDS	Up to 1920 x 1200 @60 Hz, Dual Channel 18/24-bit colay
eDP	UP to 4096 x 2340 @60Hz
Backlight Control	Voltage / PWM
Environment & Power & ME	
Battery	Lithium battery
Power Requirement	12VDC
Operating Temperature	32°F ~140°F (0°C ~ 60°C)
Storage Temperature	-40°F ~185°F (-40°C ~85°C)
Operating Humidity	0% ~ 90%RH, non-condensing
Certificate	CE & FCC
Form Factor	Mini-ITX, 6.7" x 6.7" (170mm x 170mm)
Weight	1.1 lb (0.5 Kg)
MTBF (Hours)	—

Features

- LGA1151 Socket For 6th Gen. Intel® Core™ i Series Processor
- DDR4 SODIMM x 2, Up to 32GB
- Two Independent Display: DP/HDMI (BOM Change), LVDS, eDP
- SATA 6.0 Gb/s x 2, Half-size Mini-Card x 1, Full/Half-size Mini-Card x 1
- PCI-Express [x1] x 1
- 12V DC
- Low Profile
- 4K for HDMI/DP/eDP



Rear Panel I/O Ports

USB	USB 3.0 x 4
Display I/O	DP/HDMI (BOM Change) x 2
Audio I/O	Mic-in x 1, Line-out x 1
LAN I/O	LAN (RJ-45) port x 2
Serial Port	—
PS/2 Port	—
Others	DC Jack x 1

Internal I/O Connectors

Storage	SATA3 (6.0Gb/s) x 2, Full Size Mini-Card (mSATA) x 1, SATA power connector x 1
USB	USB 2.0 (2x5PIN, 2.00mm) x 2 ports support additional 4 USB.
Display I/O	40-pin LVDS connector x 1, 40-pin eDP connector x 1, LVDS 3.3V/5V jumper x 1, LCD DC / PWM mode jumper x 1, LCD backlight connector (inverter) x 1, LCD backlight 12V/5V jumper x 1
Audio I/O	AAFP x 1, Speaker x 1
Serial Port	Boxer header for COM (RS-232/422/485) x 1, Boxer header for COM (RS-232) x 1
PS/2 Port	—
Parallel Port	—
DIO	Digital I/O box header x 1
FAN	4-pin CPU Fan connector x 1, 4-pin Chassis Fan connector x 1
Power	12V AUX Power Connector x 1, AT/ATX mode select jumper (optional) x 1
Others	Front Panel connector x 1, Chassis Intrusion x 1, Buzzer on board (pin header) x 1, CMOS jumper x 1

OS

OS Support	Windows® 7 32/64-bit, Windows® 8.1 32/64-bit, Windows® 10 64-bit, Linux Fedora
------------	--

Packing List

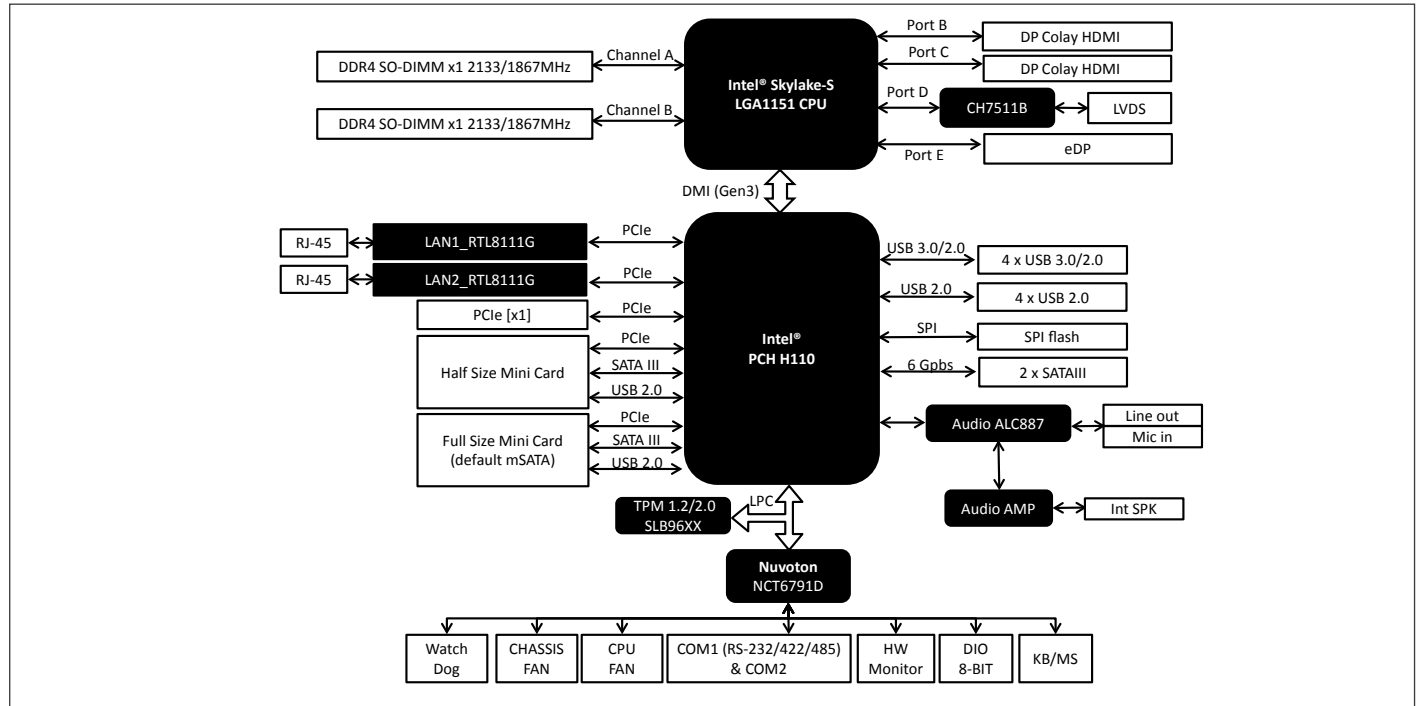
- SATA Cable
- SATA Power Cable
- I/O Shield
- Product DVD
- EMB-H110B

Optional Accessories

Part Number	Description
1759200172	CPU Cooler (2-Ball, Screw with Retention Plate)
175921156B	CPU Cooler (2-Ball, Push-pin Type)
Cooler-65W-01	CPU Cooler
1709100201	USB 2.0 Cable (10P, 200MM, p=2.00mm, w/ bracket)
1701100206	COM Cable (200MM, p=2.00mm)
1702150300	SATA Power Cable, 4P, 2.54mm

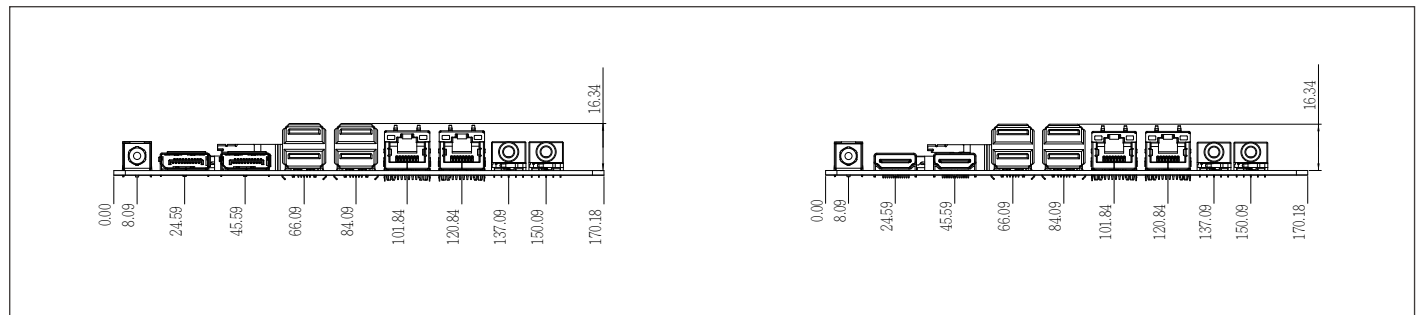
EMB-H110B

Block Diagram



Dimension

Unit: mm



Ordering Information

Part number	CPU	RAM	Fan/Fanless	Display	Storage	LVDS	LAN	USB	RS-232	RS-232/422/485	Expansion Slot	Power	TPM	Temp.
EMB-H110B-A10-MS	Socket	SO-DIMM x2	Fan	HDMI x 2, LVDS x 1, eDP x 1	SATA3 x 2, Full/Half Size Mini Card (mSATA) x 1	Dual Channel 18/24 bit colay	GbE x 2	USB3.0 x 4, USB2.0 x 4	1	1	PCIe[x1] x 1 Half Size Mini Card (PCIe+USB) x 1	12V DC	No	32°F ~ 140°F (0°C ~ 60°C)